

Li-Ion Power Gauge™ Module

Features

- Complete bq2050 Power Gauge solution for Li-Ion battery packs
- Battery information available over a single-wire bidirectional serial port
- Battery state-of-charge monitoring for 2- to 4-cell series applications
- On-board regulator allows direct connection to the battery
- “L” version includes push-button activated LEDs to display state-of-charge information
- Nominal capacity pre-configured
- Compact size for battery pack integration

General Description

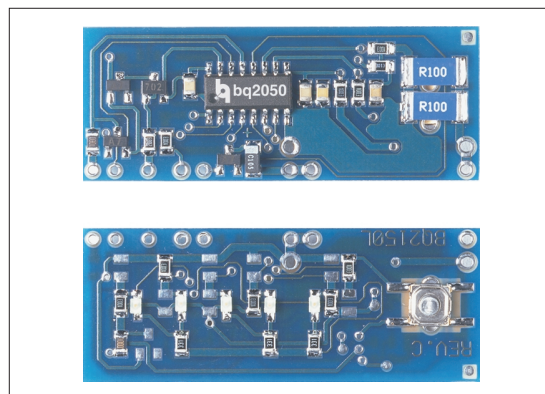
The bq2150 Power Gauge Module provides a complete and compact solution for capacity monitoring of Li-Ion battery packs. Designed for battery pack integration, the bq2150 incorporates a bq2050 Gas Gauge IC, a current sense resistor, and all other components necessary to accurately monitor and display the capacity of 2 to 4 series cells.

The bq2150L includes five LEDs to display remaining capacity in 20% increments of the learned capacity. The LEDs are activated with the onboard push-button switch.

Contacts are provided on the bq2150 for direct connection to the battery stack (BAT+, BAT-) and the serial communications port (DQ). The RBI input provides backup power to the bq2050 in the event that the cells are removed or the battery is turned off. The bq2150 has a 1µF capacitor onboard connected to RBI to supply backup power for about an hour. In battery packs that use high-side FETs to control the charge/discharge of the Li-Ion cells, the RBI input can be wired to a single cell to provide prolonged data retention times. The SD input allows an external signal (active low) to turn the bq2050 IC off to minimize internal current consumption of the battery pack and maximize storage life of the pack in the system. When turned off, the bq2050 is non-functional, and the RBI power source maintains register information. Please refer to the bq2050 data sheet for the specifics on the operation of the gas gauge.

Unitrode configures the bq2150 based on the information requested in Table 1. The configuration defines the number of series cells, the nominal battery pack capacity, and the Li-Ion battery type (coke or graphite anode). Figure 1 shows how the module connects to the cells.

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A module development kit is also available for the bq2150. The bq2150B-KT or the bq2150LB-KT includes one configured module and the following:

- 1) An interface board that allows connection to the serial port of an AT-compatible computer.
- 2) Menu-driven software to display charge/discharge activity and to allow user interface to the bq2050 from any standard DOS PC.
- 3) Source code for the TSR.

Pin Descriptions

P1	DQ/Serial Communications port
P2	No connect
P3	BAT+/Battery positive/pack positive
P4	SD/Shutdown
P5	RBI/Register backup input
P6	GND/Ground
P7	PACK-/Pack negative
P8	BAT-/Battery negative

bq2150

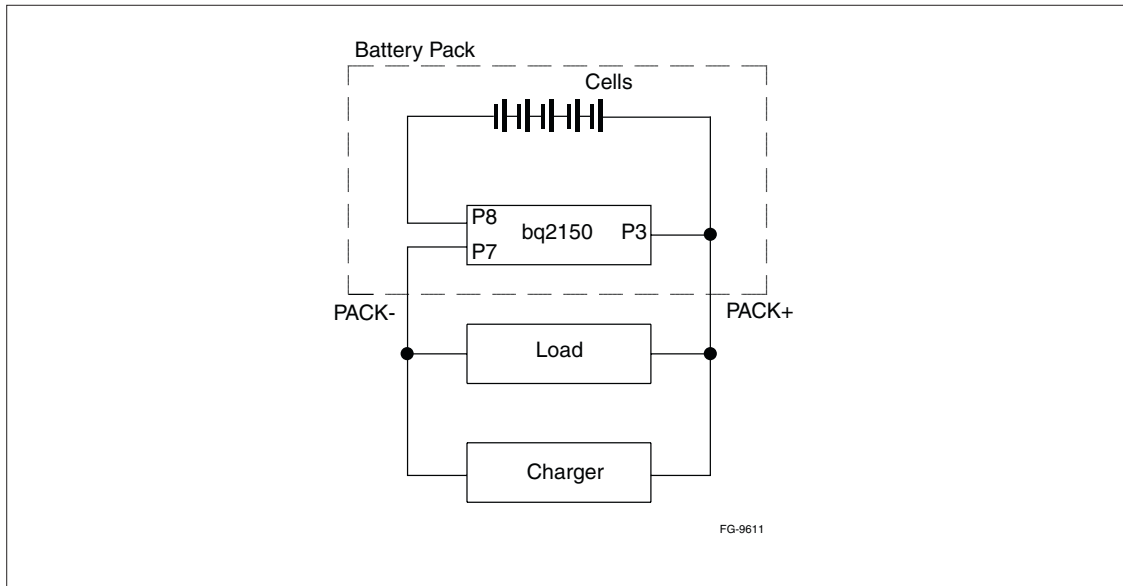


Figure 1. Module Connection Diagram

Table 1. bq2150 Module Configuration

Customer Name: _____

Contact: _____ Phone: _____

Address: _____

Sales Contact: _____ Phone: _____

Number of series battery cells (2-4) _____

Coke or graphite cell anode _____

Battery pack capacity (mAh) _____

Discharge rate into load (3.0A max) Min. _____ Avg. _____ Max. _____

Charge rate (3.0A max) _____

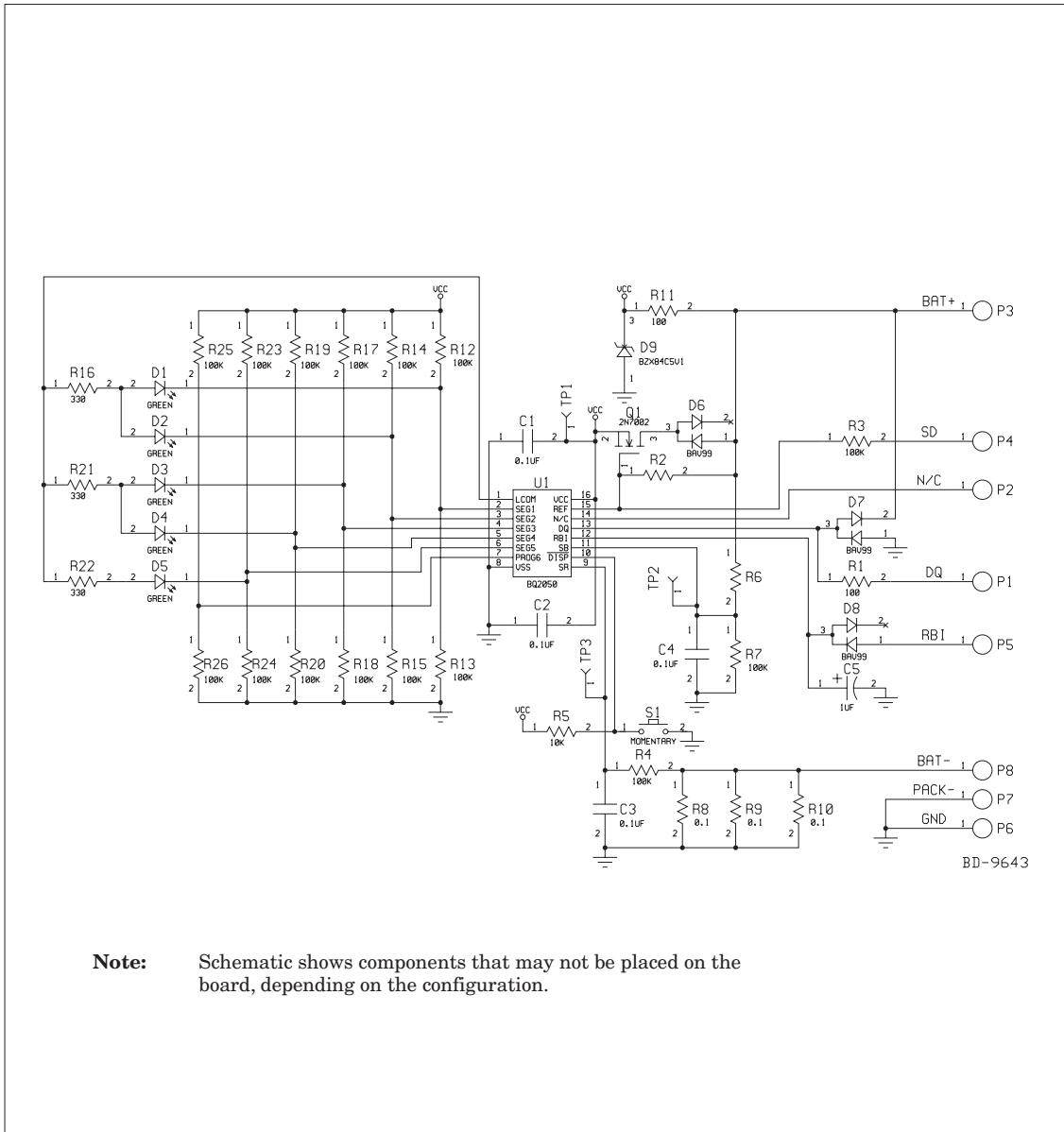
Nominal Available Capacity after reset
(Programmed Capacity or Zero) _____

Self-discharge compensation (Y/N) _____

LEDs and switch (Y/N) _____

FAE Approval: _____ Date: _____

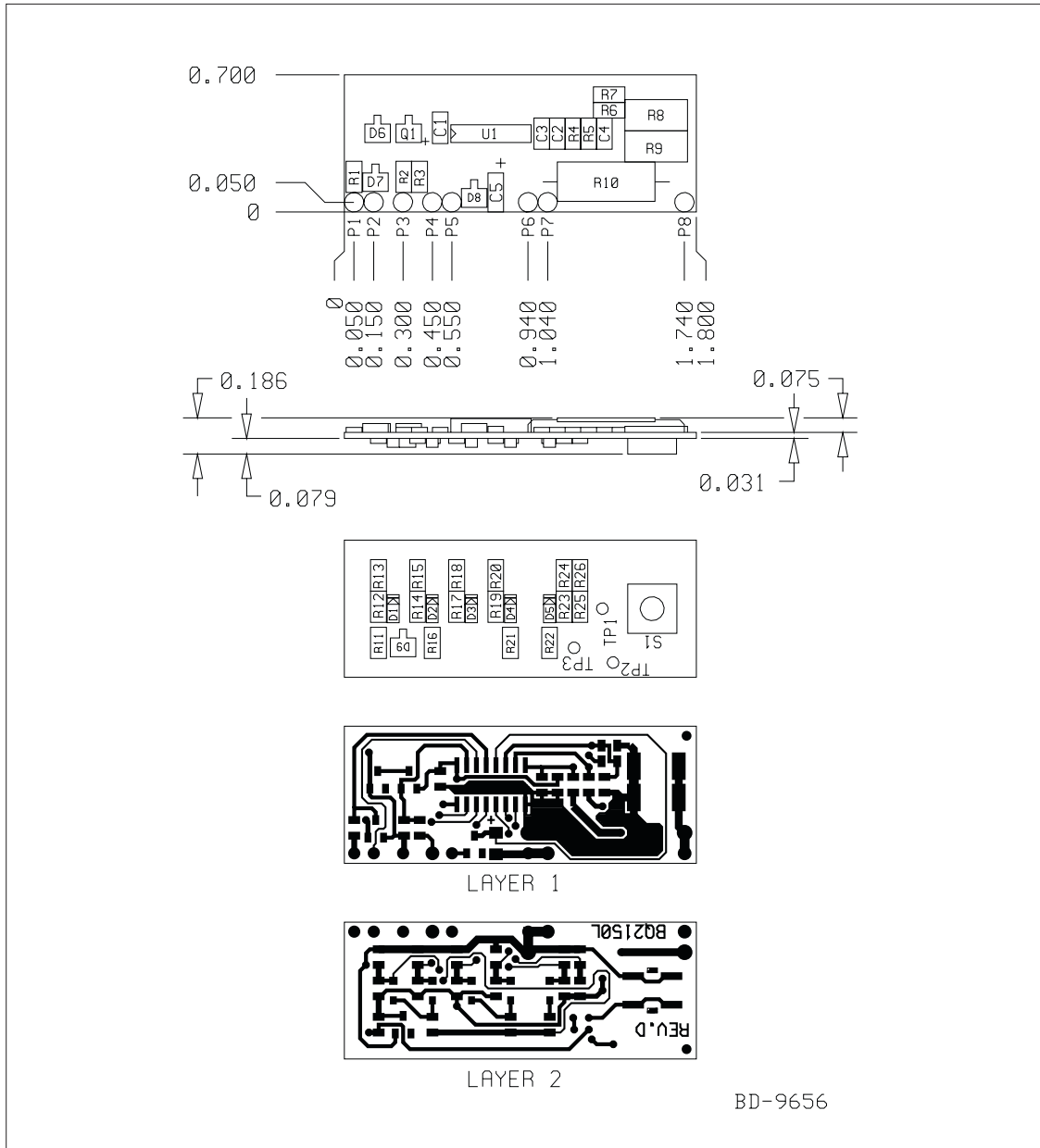
bq2150 Schematic



Note: Schematic shows components that may not be placed on the board, depending on the configuration.

bq2150

bq2150 Board



Absolute Maximum Ratings

Symbol	Parameter	Minimum	Maximum	Unit	Conditions
V _{CC}	Relative to V _{SS}	-0.3	+7.0	V	bq2050
All other pins	Relative to V _{SS}	-0.3	+7.0	V	bq2050
PSR	Continuous sense resistor power dissipation	-	3	W	Thru-hole sense resistor
		-	1	W	Surface-mount sense resistor
ICHG	Continuous charge/discharge current	-	3.0	A	
TOPR	Operating temperature	0	+70	°C	Commercial
TSTR	Storage temperature	-40	+85	°C	

Note: Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

DC Electrical Characteristics (T_A = TOPR)

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Conditions/Notes
NumCell	Number of series cells in battery pack	2	-	4	-	
BAT+	Positive terminal of pack	GND	NumCell * 3.6V	NumCell * 5.4V	V	
BAT-	Negative terminal of pack	GND - 0.3	-	GND+2.0	V	
I _{CC}	Supply current at BAT _{1P} terminal (no external loads)	-	200	300	μA	
RDQ	Internal pull-down	500k	-	-	Ω ¹	
I _{OL}	Open-drain sink current DQ	-	-	5.0	mA ¹	
V _{OL}	Open-drain output low, I _{OL} DQ	-	-	0.5	V ¹	I _{OL} < 5mA
V _{IHDQ}	DQ input high	2.5	-	-	V ¹	
V _{ILDQ}	DQ input low	-	-	0.8	V ¹	
V _{OS}	Voltage offset	-	-	150	μV ¹	

Note: 1. Characterized on PCB, IC 100% tested.

bq2150

DC Voltage Thresholds (T_A = T_{OPR})

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
VEDVF	Final empty warning	1.45	1.47	1.49	V	BAT+/(2*NumCell) ¹
VEDV1	First empty warning	1.50	1.52	1.55	V	BAT+/(2*NumCell) ¹
V _{MCV}	Maximum single-cell voltage	2.20	2.25	2.30	V	BAT+/(2*NumCell) ¹
VSRO	Sense range	-300	-	+2000	mV	SR, VSR + VOS ²
VSRQ	Valid charge	210	-	-	μV	VSR + VOS ^{2, 3}
VSRD	Valid discharge	-	-	-200	μV	VSR + VOS ^{2, 3}

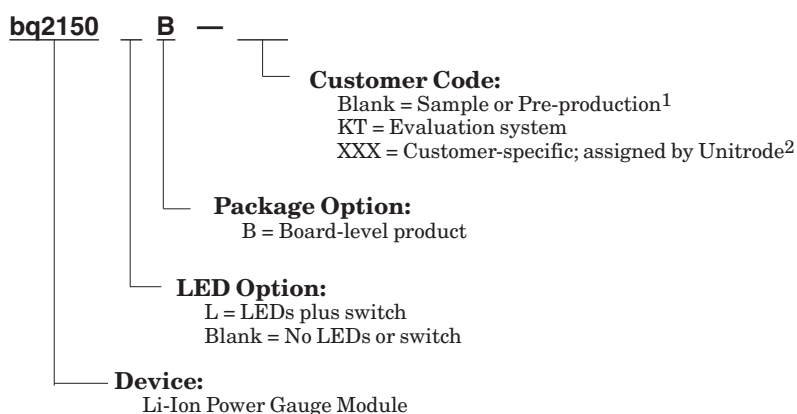
- Notes:**
1. At SB input of bq2050
 2. At SR input of bq2050.
 3. Default value; value set in DMF register.

Data Sheet Revision History

Change No.	Page No.	Description
1	2	Updated Table 1 to include 3.0A limit
1	5	Added 3.0A maximum continuous charge/discharge current specification

Note: Change 1 = May 1999 B changes from April 1999.

Ordering Information



- Notes:**
1. Requires configuration sheet (Table 1)
 2. Example production part number: bq2150LB-001

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